

S/N 10/023,819

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Biju Chandran et al. Examiner: John Vigushin
Serial No.: 10/023,819 Group Art Unit: 2841
Filed: December 21, 2001 Docket: 884.A27US1
Title: CHIP-JOIN PROCESS TO REDUCE ELONGATION MISMATCH BETWEEN
THE ADHERENTS AND SEMICONDUCTOR PACKAGE MADE THEREBY
Customer Number: 21186

PETITION TO WITHDRAW FROM ISSUANCE UNDER 37 CFR 1.313(c)


Mail Stop 313(c)
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

The above-identified patent application was allowed on April 25, 2005 and the Issue Fee was paid on July 25, 2005. Applicants respectfully request that the above-identified patent application be withdrawn from Issue so that an Information Disclosure Statement may be submitted. Additionally, Applicants have enclosed a Request for Continued Examination transmittal and the requisite fee, which Petitioner wishes to enter on even date herewith.

Please charge the petition fee of \$130.00 as set forth in § 1.17(h) which is required pursuant to 37 C.F.R. § 1.313(a) to Deposit Account 19-0743.

The Examiner is invited to telephone Applicants' attorney at (352) 373-8804 to facilitate the prosecution of this application. If necessary, please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

Respectfully submitted,
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By /  /
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